eric.ericturner@gmail.com

 $(703) \ 401 - 0\overline{537}$

EDUCATION University of California - Berkeley

Ph.D. in Electrical Engineering and Computer Sciences

May 2015

3D and 2D surface reconstruction algorithms for architectural modeling

System hardware design and assembly

GPA: 4.00/4.00

University of California - Berkeley

M.S. in Electrical Engineering and Computer Sciences

May 2013

GPA: 4.00/4.00

Carnegie Mellon University

B.S. in Electrical and Computer Engineering

May 2011

QPA: 3.91/4.00 - Dean's List Minors in Physics, Computer Science

WORK EXPERIENCE

Indoor Reality, Inc.

09/2015 - Present

Chief Technical Officer (CTO)

Principal Investigator on multiple grants.

Technology lead in developing hardware and software for indoor building modeling **Signetron, Inc.** 07/2015 - Present

Software Architect

Developed algorithms and software for automatic indoor modeling

EECS Department - UC Berkeley

01/2015 - 05/2015

Graduate Student Instructor

Taught discussion sections, held office hours, graded homeworks/exams

Speir Technologies

01/2013 - 01/2014

Software Development Consultant

Developed prototype demo application and 3D modeling algorithms

MIT Lincoln Laboratory

05/2011 - 08/2011

Summer Intern - Group 104: Intelligence and Decision Theory

Developed algorithms for creation of synthetic test data for SAR CCD track-finding **Qualcomm** 05/2010 - 08/2010

Software Summer Intern - QCT Modem Integration Team

Developed/automated methodology for optimizing and removing redundancies in client specs of processor builds

COMPUTER SKILLS

Programming Languages: Java, C/C++, BASH, Python, SML, Basic, NASM, x86,

Perl, JavaScript

Markup Languages: HTML, LaTeX

Software: Matlab, Mathematica, Maple, Unity, Autodesk, Visual Studio

Frameworks: Eigen, OpenCV, OpenGL, Qt, Android, Spring, Processing, XStream

AWARDS

Awarded Best Student Paper - GRAPP 2014

01/2014

Awarded NSDEF Fellowship

09/2013 - 05/2016

Presented at CMU Meeting of the Minds

05/2011

1st Place Lockheed Martin ECE Undergraduate Project 3rd Place CIT Honors Research Poster Competiton